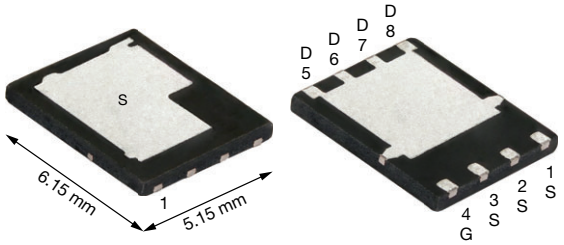
N-Channel 45 V (D-S) 175 °C MOSFET

PowerPAK® SO-8DC



Top View | Bottom View

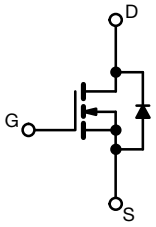
FEATURES

- TrenchFET® Gen IV power MOSFET
- 45 V Drain-source break-down voltage
- Tuned for low Q_g and Q_{oss}
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Motor drive control



N-Channel MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	45
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00120
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00180
Q_g typ. (nC)	50.5
I_D (A) [a]	228
Configuration	Single

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR608EP-T1-RE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	45	V
Gate-source voltage		V_{GS}	+20, -16	
Continuous drain current (T_J = 175 °C)	T_C = 25 °C	I_D	228	A
	T_C = 70 °C		190	
	T_A = 25 °C		56 [b, c]	
	T_A = 70 °C		47 [b, c]	
Pulsed drain current (t = 100 µs)		I_{DM}	400	
Continuous source-drain diode current	T_C = 25 °C	I_S	113	
	T_A = 25 °C		6.8 [b, c]	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	50	
Single pulse avalanche energy		E_{AS}	125	mJ
Maximum power dissipation	T_C = 25 °C	P_D	125	W
	T_C = 70 °C		87.5	
	T_A = 25 °C		7.5 [b, c]	
	T_A = 70 °C		5.25 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) [d, e]			260	

Notes

a. Based on T_C = 25 °C
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8DC is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient [a, b]	t ≤ 10 s	R_{thJA}	15	20	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	0.9	1.2	
Maximum junction-to-case (source)	Steady state	R_{thJC}	1.1	1.4	

Notes
a. Surface mounted on 1" x 1" FR4 board
b. Maximum under steady state conditions is 54 °C/W

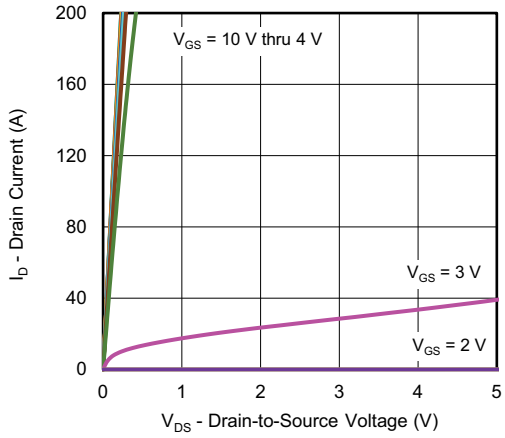
SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	45	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = 10 mA	-	29	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA	-	-5.8	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	1.1	-	2.3	V
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = +20, -16 V	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{DS} = 45 V, V_{GS} = 0 V	-	-	1	µA
		V_{DS} = 45 V, V_{GS} = 0 V, T_J = 55 °C	-	-	10	
On-state drain current [a]	$I_{D(on)}$	V_{DS} ≥ 5 V, V_{GS} = 10 V	50	-	-	A
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 20 A	-	0.00100	0.00120	Ω
		V_{GS} = 4.5 V, I_D = 20 A	-	0.00136	0.00180	
Forward transconductance [a]	g_{fs}	V_{DS} = 10 V, I_D = 20 A	-	120	-	S
Dynamic [b]						
Input capacitance	C_{iss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz	-	8900	-	pF
Output capacitance	C_{oss}		-	1244	-	
Reverse transfer capacitance	C_{rss}		-	120	-	
C_{rss}/C_{iss} ratio			-	0.0135	0.0270	-
Total gate charge	Q_g	V_{DS} = 20 V, V_{GS} = 10 V, I_D = 20 A	-	111	167	nC
		V_{DS} = 20 V, V_{GS} = 4.5 V, I_D = 20 A	-	50.5	76	
Gate-source charge	Q_{gs}		-	26	-	
Gate-drain charge	Q_{gd}		-	7.8	-	
Output charge	Q_{oss}	V_{DS} = 20 V, V_{GS} = 0 V	-	59	-	
Gate resistance	R_g	f = 1 MHz	0.3	0.88	1.5	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, R_L = 1 Ω I_D ≅ 20 A, V_{GEN} = 10 V, R_g = 1 Ω	-	19	38	ns
Rise time	t_r		-	10	20	
Turn-off delay time	$t_{d(off)}$		-	50	100	
Fall time	t_f		-	8	16	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, R_L = 1 Ω I_D ≅ 20 A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	52	104	
Rise time	t_r		-	86	172	
Turn-off delay time	$t_{d(off)}$		-	50	100	
Fall time	t_f		-	25	50	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	T_C = 25 °C	-	-	113	A
Pulse diode forward current (t_p = 100 µs)	I_{SM}		-	-	400	
Body diode voltage	V_{SD}	I_S = 10 A	-	0.7	1.1	V
Body diode reverse recovery time	t_{rr}	I_F = 10 A, di/dt = 100 A/µs, T_J = 25 °C	-	52	104	ns
Body diode reverse recovery charge	Q_{rr}		-	71	142	nC
Reverse recovery fall time	t_a		-	32	-	ns
Reverse recovery rise time	t_b		-	20	-	

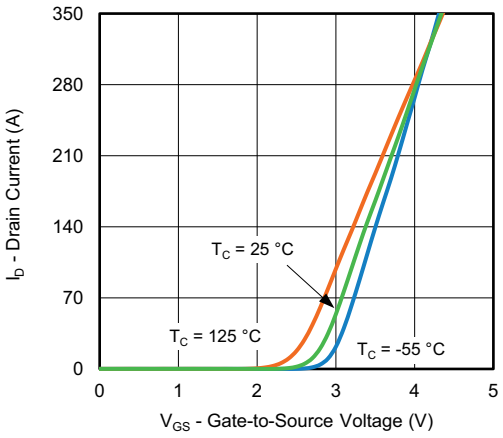
Notes
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

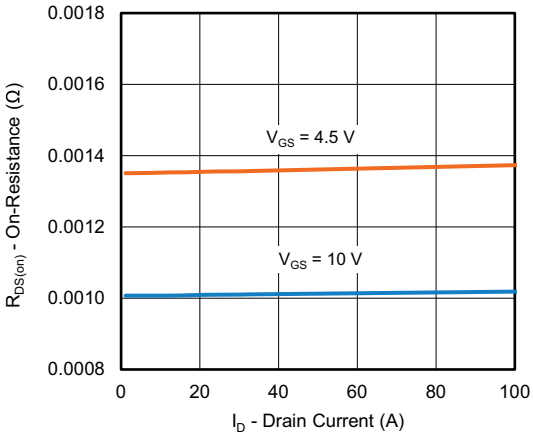
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



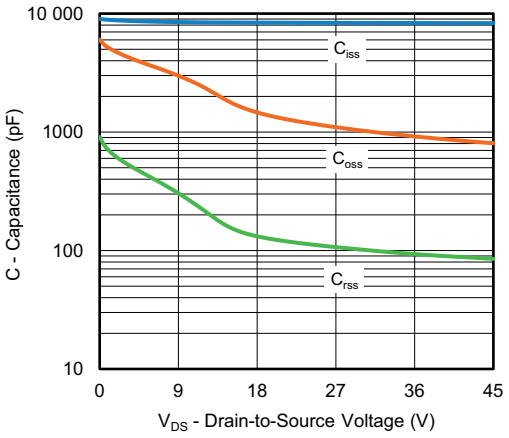
Output Characteristics



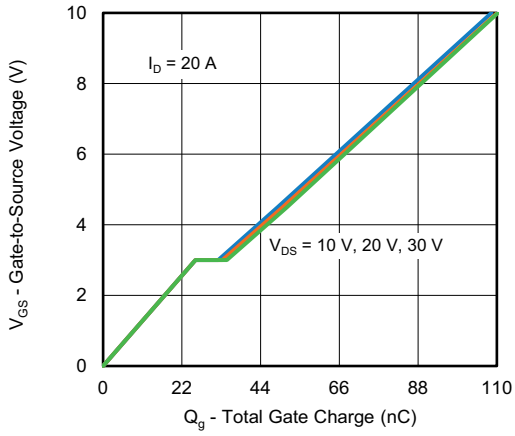
Transfer Characteristics



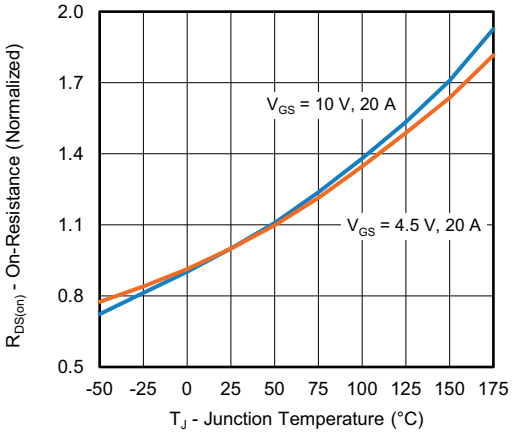
On-Resistance vs. Drain Current



Capacitance

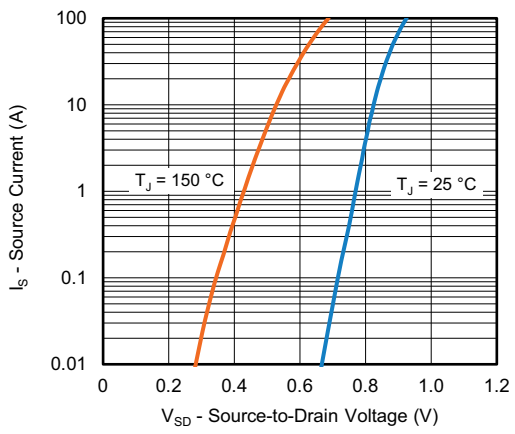


Gate Charge

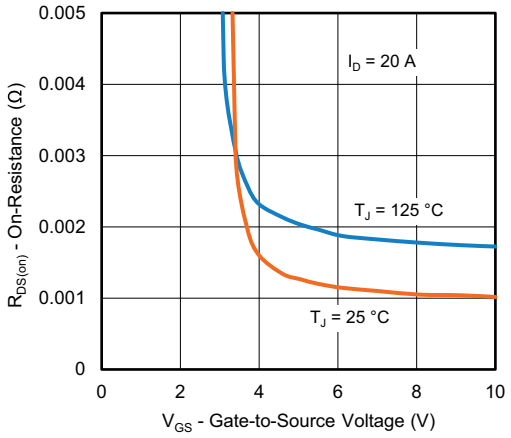


On-Resistance vs. Junction Temperature

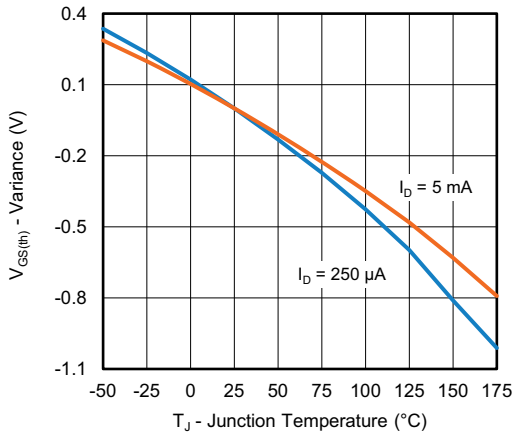
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



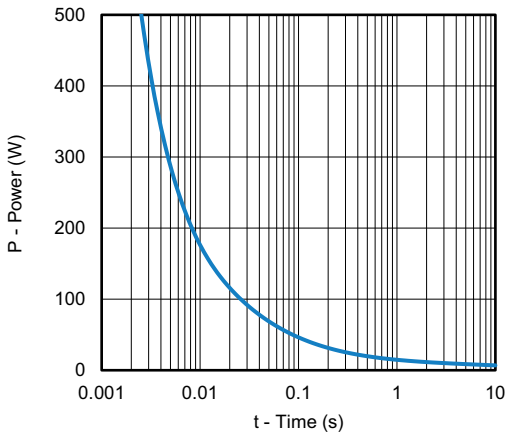
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

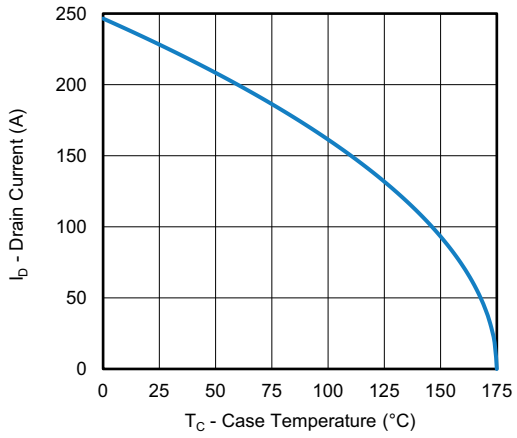


Threshold Voltage

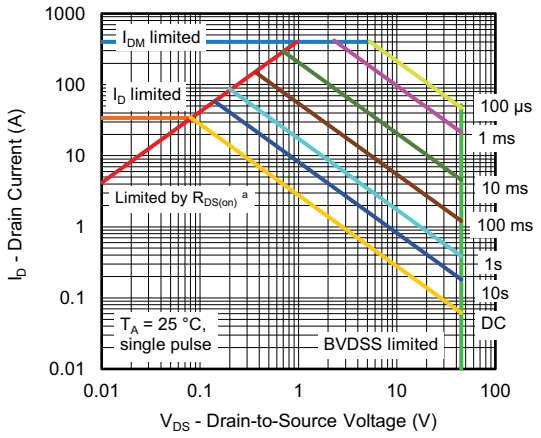


Single Pulse Power, Junction-to-Ambient

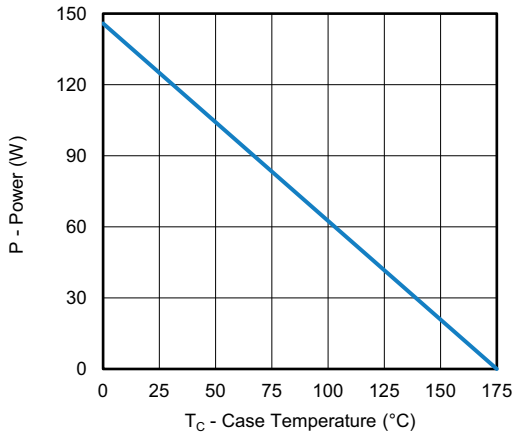
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



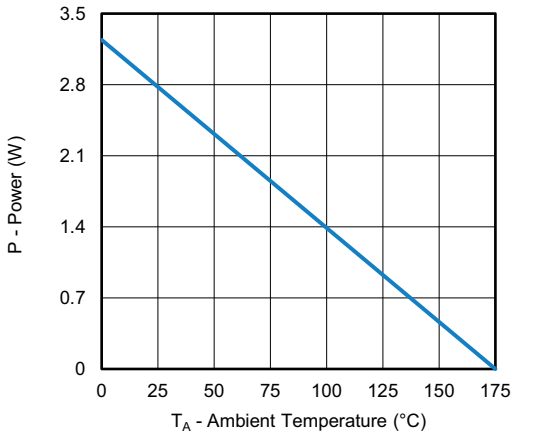
Current Derating [a]



Safe Operating Area [b]



Power, Junction-to-Case



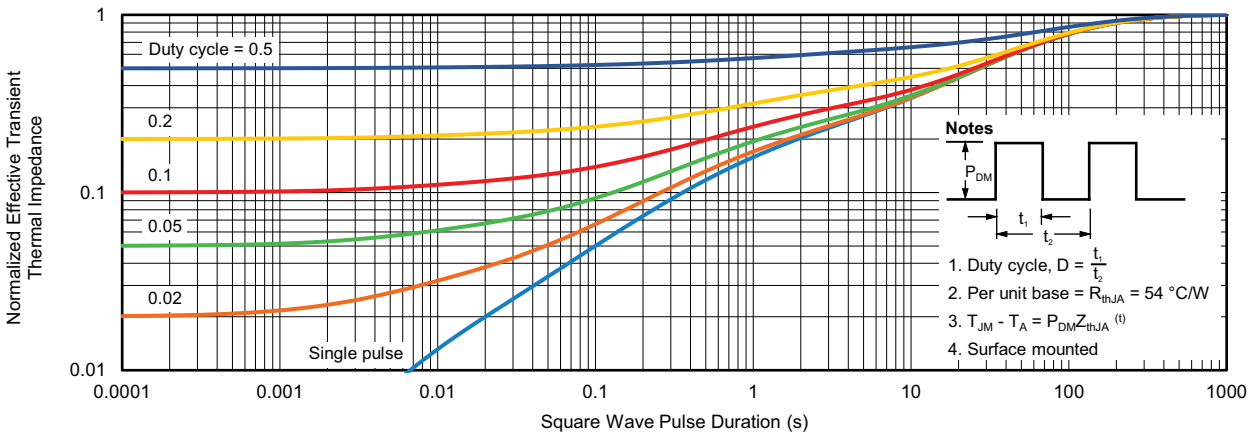
Power, Junction-to-Ambient

Notes

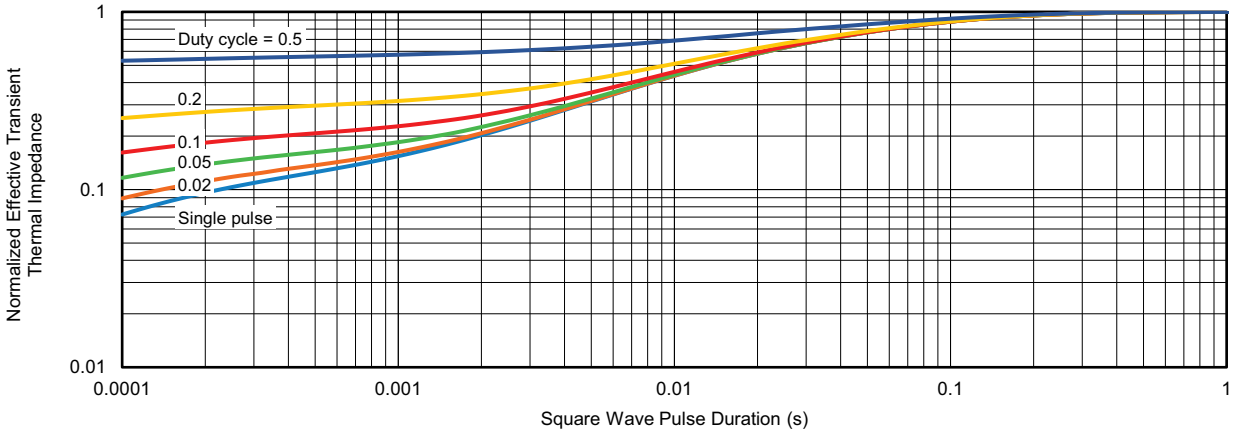
a. The power dissipation P_D is based on T_J max. = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

b. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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